



PATENT APPLICATION
Docket No. 9898-208
Client No. SS-15400-US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Ki-Won CHOI Conf. No. 6747
Serial No. 10/055,266 Examiner: Vu, Quang D
Filed: January 22, 2002 Art Unit: 2811
For: SEMICONDUCTOR PACKAGE HAVING CHANGED
 SUBSTRATE DESIGN USING SPECIAL WIRE BONDING

Mail Stop NON FEE AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Responsive to the Office Action dated February 13, 2004, enclosed is an amendment in the above-identified application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED					
For:	Number After Amendment	Previous Number	Extra	Rate	Additional Fee
Total Claims	17	17	0	x \$18 =	\$0.00
Independent Claims	3	3	0	x \$86 =	\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ Exhibit A, 1 drawing sheet from U.S. Patent No. US 6,448,664 B1.
☒ Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.

Customer No. 20575

Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

Alan T. McCollom
Reg. No. 28,881

MARGER JOHNSON & McCOLLOM, P.C.
1030 SW Morrison Street
Portland, OR 97205
(503) 222-3613

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Non Fee Amendment Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450
Date: May 13, 2004

Adrienne Chocholak